

# P-Channel Enhancement-Mode Vertical DMOS FET

#### **Features**

- High input impedance and high gain
- Low power drive requirement
- Ease of paralleling
- Low C<sub>ISS</sub> and fast switching speeds
- Excellent thermal stability
- Integral source-drain diode
- Free from secondary breakdown

#### **Applications**

- Logic level interfaces ideal for TTL and CMOS
- Solid state relays
- Analog switches
- Power management
- Telecom switches

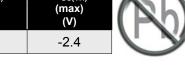
#### General Description

The Supertex TP5335 is a low threshold enhancementmode (normally-off) transistor utilizing an advanced vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

**Ordering Information** 

Device	Package Option	BV <sub>DSS</sub> /BV <sub>DGS</sub>	R <sub>DS(ON)</sub>	V <sub>GS(TH)</sub>		
Device	TO-236AB (SOT-23)	(V)	(max) (Ω)	(max) (V)		
TP5335	TP5335K1-G	-350	30	-2.4		
-G indicates packa	ge is RoHS compliant ('Green')					





Absolute Maximum Ratings

Absolute maximum ratings								
Parameter	Value							
Drain-to-source voltage	BV <sub>DSS</sub>							
Drain-to-gate voltage	$BV_{DGS}$							
Gate-to-source voltage	±20V							
Operating and storage temperature	-55°C to +150°C							
Soldering temperature*	300°C							

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

### **Pin Configuration**



TO-236AB (SOT-23) (K1)

## **Product Marking Information**

P3SW

W = Code for week sealed \_ = "Green" Packaging

Package may or may not include the following marks: Si or



TO-236AB (SOT-23) (K1)

Distance of 1.6mm from case for 10 seconds.

### **Thermal Characteristics**

Package	I <sub>D</sub> (continuous) <sup>†</sup> (mA)	I <sub>D</sub> (pulsed) (mA)	Power Dissipation @T <sub>A</sub> = 25°C (W)	θ <sub>jc</sub> (°C/W)	θ <sub>ja</sub> (°C/W)	I <sub>DR</sub> † (mA)	I <sub>DRM</sub> (mA)
TO-236AB (SOT-23)	-85	-400	0.36	200	350	-85	-400

Notes

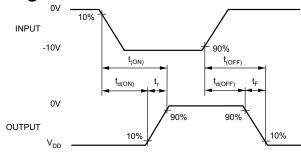
### **Electrical Characteristics** (T<sub>A</sub> = 25°C unless otherwise specified)

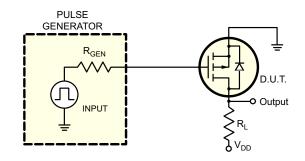
Sym	Parameter	Min	Тур	Max	Units	Conditions	
BV <sub>DSS</sub>	Drain-to-source breakdown voltage	-350	-	-	V	$V_{GS} = 0V, I_{D} = -100\mu A$	
V <sub>GS(TH)</sub>	Gate threshold voltage	-1.0	ı	-2.4	V	$V_{DS} = V_{GS}$ , $I_{D} = -1.0$ mA	
$\Delta V_{GS(TH)}$	Change in V <sub>GS(TH)</sub> with temperature	ı	1	4.5	mV/°C	$V_{DS} = V_{GS}$ , $I_{D} = -1.0$ mA	
I <sub>GSS</sub>	Gate body leakage current	-	1	-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
		-	•	-10	μA	$V_{DS}$ = Max rating, $V_{GS}$ = 0V	
I <sub>DSS</sub>	Zero gate voltage drain current	ı	ı	-1.0	mA	$V_{DS} = 0.8$ Max Rating, $V_{GS} = 0V$ , $T_A = 125^{\circ}C$	
		ı	1	-5.0	nA	$V_{GS} = 0V, V_{DS} = -330V$	
	On-state drain current	-200	-	-	mA	$V_{GS} = -4.5V, V_{DS} = -25V$	
I <sub>D(ON)</sub>	On-state drain current	-400	ı	-	IIIA	$V_{GS} = -10V, V_{DS} = -25V$	
D	Static drain-to-source on-state	ı	ı	75	Ω	$V_{GS} = -4.5V, I_{D} = -150mA$	
R <sub>DS(ON)</sub>	resistance	ı	-	30	22	$V_{GS} = -10V, I_{D} = -200 \text{mA}$	
$\Delta R_{DS(ON)}$	Change in R <sub>DS(ON)</sub> with temperature	-	-	1.7	%/°C	$V_{GS} = -10V, I_{D} = -200mA$	
G <sub>FS</sub>	Forward transconductance	125	-	-	mmho	$V_{DS} = -25V, I_{D} = -200mA$	
C <sub>ISS</sub>	Input capacitance	-	-	110		$V_{GS} = 0V,$ $V_{DS} = -25V,$ f = 1MHz	
C <sub>oss</sub>	Common source output capacitance	-	-	60	pF		
C <sub>RSS</sub>	Reverse transfer capacitance	-	-	22			
t <sub>d(ON)</sub>	Turn-on delay time	-	-	20		V <sub>DD</sub> = -25V,	
t <sub>r</sub>	Rise time	-	-	15	ne		
t <sub>d(OFF)</sub>	Turn-off delay time	-	-	25	ns	$I_D = -150 \text{mA},$ $R_{GEN} = 25\Omega,$	
t <sub>f</sub>	Fall time	-	-	25		GLIN	
V <sub>SD</sub>	Diode forward voltage drop	-	-	-1.8	V	$V_{GS} = 0V, I_{SD} = -200 \text{mA}$	
t <sub>rr</sub>	Reverse recovery time	-	800	-	ns	$V_{GS} = 0V, I_{SD} = -200 \text{mA}$	

Notes:

- 1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

### **Switching Waveforms and Test Circuit**

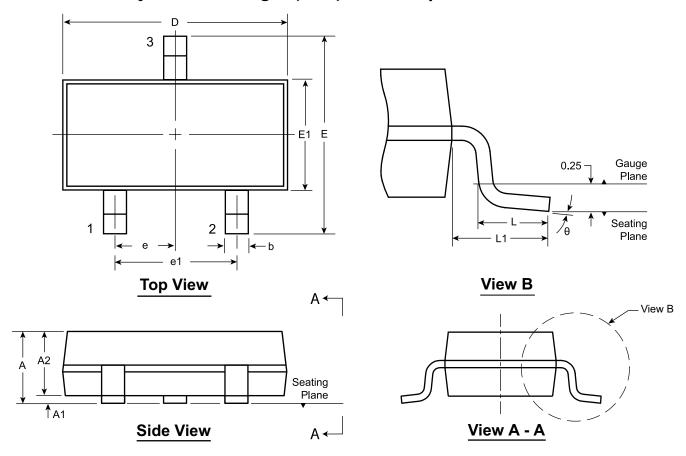




 $<sup>\</sup>uparrow$   $I_{\scriptscriptstyle D}$  (continuous) is limited by max rated  $T_{\scriptscriptstyle .r}$ 

# 3-Lead TO-236AB (SOT-23) Package Outline (K1/T)

2.90x1.30mm body, 1.12mm height (max), 1.90mm pitch



Symb	ol	Α	A1	A2	b	D	Е	E1	е	e1	L	L1	θ
Dimension (mm)	MIN	0.89	0.01	0.88	0.30	2.80	2.10	1.20	0.05	1 90	0.20 <sup>†</sup>		<b>0</b> °
	NOM	-	-	0.95	-	2.90	-	1.30	0.95 BSC		0.50 0.54 REF	0.54 REE	-
	MAX	1.12	0.10	1.02	0.50	3.04	2.64	1.40	500	500	0.60	IVEI	<b>8</b> º

JEDEC Registration TO-236, Variation AB, Issue H, Jan. 1999.

Drawings not to scale.

Supertex Doc.#: DSPD-3TO236ABK1, Version B072208.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <a href="http://www.supertex.com/packaging.html">http://www.supertex.com/packaging.html</a>.)

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<sup>†</sup> This dimension is a non-JEDEC dimension.